

	Hits	Search Text	DBs
16	18	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4 or glass) same (pattern or circuit\$4 or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4 or paste) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet))) and firing	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
17	50	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4 or glass) same (pattern or circuit\$4 or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4 or paste) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet) or (ceramic near9 sheet)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
18	29	(multi\$4layer near9 circuit) and ((board or circuit or panel or substrate or carrier) same (transmit\$5 or transparent or non\$\$block\$4 or glass) same (pattern or circuit\$4 or line or wiring)) and ((photo\$4cur\$5 or curable or photoresist or resist or photosensitive) same (ceramic or slurr\$4) same (coat\$4 or deposit\$4 or layer) same (expos\$4 or irradiat\$4 or illuminat\$4) same (light or UV or EUV or DUV or radiation)) and develop\$4 and (laminat\$4 same (sheet or (circuit near12 (board or substrate or surface or panel)) or (green near9 sheet)))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB